5V ECL 1:2 Differential Fanout Buffer

The MC10EL/100EL11 is a differential 1:2 fanout buffer. The device is functionally similar to the E111 device but with higher performance capabilities. The within-device skew and propagation delay is significantly improved over the E111.

The differential inputs of the EL11 employ clamping circuitry to maintain stability under open input conditions. If the inputs are left open (pulled to V_{EE}) the Q outputs will go LOW.

The 100 Series contains temperature compensation.

- 265 ps Propagation Delay
- 5 ps Skew Between Outputs
- PECL Mode Operating Range: $V_{CC} = 4.2 \text{ V}$ to 5.7 with $V_{EE} = 0 \text{ V}$
- NECL Mode Operating Range: $V_{CC} = 0 \text{ V}$ with $V_{EE} = -4.2 \text{ V}$ to -5.7 V
- Internal Input Pulldown Resistors

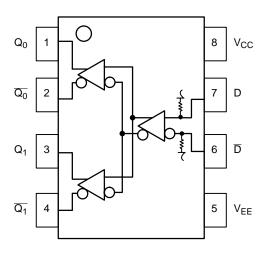


Figure 1. Logic Diagram and Pinout Assignment

PIN DESCRIPTION

PIN	FUNCTION
D, D Q0, Q0; Q1, Q1 V _{CC} V _{EE}	ECL Data Inputs ECL Data Outputs Positive Supply Negative Supply



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MARKING DIAGRAMS*









TSSOP-8 DT SUFFIX CASE 948R





H = MC10 K = MC100 L = Wafer Lot Y = Year

A = Assembly Location W = Work Week

ORDERING INFORMATION

Device	Package	Shipping†
MC10EL11D	SO-8	98 Units/Rail
MC10EL11DR2	SO-8	2500 Tape & Reel
MC100EL11D	SO-8	98 Units/Rail
MC100EL11DR2	SO-8	2500 Tape & Reel
MC10EL11DT	TSSOP-8	98 Units/Rail
MC10EL11DTR2	TSSOP-8	2500 Tape & Reel
MC100EL11DT	TSSOP-8	98 Units/Rail
MC100EL11DTR2	TSSOP-8	2500 Tape & Reel

[†]For additional tape and reel information, refer to Brochure BRD8011/D.

^{*}For additional marking information, refer to Application Note AND8002/D.

ATTRIBUTES

Characteris	tics	Value				
Internal Input Pulldown Resistor	Internal Input Pulldown Resistor					
Internal Input Pullup Resistor	N/A					
ESD Protection	Human Body Model Machine Model	> 1 KV > 100 V				
Moisture Sensitivity, Indefinite Time C	Out of Drypack (Note 1)	Level 1				
Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in				
Transistor Count		44				
Meets or Exceeds JEDEC Spec EIA/JESD78 IC Latchup Test						

^{1.} For additional information, see Application Note AND8003/D.

MAXIMUM RATINGS (Note 2)

Symbol	Parameter	Condition 1	Condition 2	Rating	Units
V _{CC}	PECL Mode Power Supply	V _{EE} = 0 V		8	V
V _{EE}	NECL Mode Power Supply	V _{CC} = 0 V		-8	V
V _I	PECL Mode Input Voltage NECL Mode Input Voltage	V _{EE} = 0 V V _{CC} = 0 V	$\begin{array}{c} V_{I} \leq V_{CC} \\ V_{I} \geq V_{EE} \end{array}$	6 -6	V V
l _{out}	Output Current	Continuous Surge		50 100	mA mA
T _A	Operating Temperature Range			-40 to +85	°C
T _{stg}	Storage Temperature Range			-65 to +150	°C
θ_{JA}	Thermal Resistance (Junction-to-Ambient)	0 LFPM 500 LFPM	SO-8 SO-8	190 130	°C/W
θЈС	Thermal Resistance (Junction-to-Case)	Standard Board	SO-8	41 to 44	°C/W
$\theta_{\sf JA}$	Thermal Resistance (Junction-to-Ambient)	0 LFPM 500 LFPM	TSSOP-8 TSSOP-8	185 140	°C/W
$\theta_{\sf JC}$	Thermal Resistance (Junction-to-Case)	Standard Board	TSSOP-8	41 to 44 ± 5%	°C/W
T _{sol}	Wave Solder	<2 to 3 sec @ 248°C		265	°C

Maximum Ratings are those values beyond which device damage may occur.

10EL SERIES PECL DC CHARACTERISTICS V_{CC} = 5.0 V; V_{EE} = 0.0 V (Note 3)

			-40 °C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I _{EE}	Power Supply Current		26	31		26	31		26	31	mA
V _{OH}	Output HIGH Voltage (Note 4)	3920	4010	4110	4020	4105	4190	4090	4185	4280	mV
V _{OL}	Output LOW Voltage (Note 4)	3050	3200	3350	3050	3210	3370	3050	3227	3405	mV
V _{IH}	Input HIGH Voltage (Single-Ended)	3770		4110	3870		4190	3940		4280	mV
V _{IL}	Input LOW Voltage (Single-Ended)	3050		3500	3050		3520	3050		3555	mV
V _{IHCMR}	Input HIGH Voltage Common Mode Range (Differential) (Note 5)	2.5		4.6	2.5		4.6	2.5		4.6	V
I _{IH}	Input HIGH Current			150			150			150	μΑ
I _{IL}	Input LOW Current	0.5			0.5			0.3			μΑ

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained.

- Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary +0.25 V / -0.5 V.
 Outputs are terminated through a 50 Ω resistor to V_{CC} 2 volts.
 V_{IHCMR} min varies 1:1 with V_{EE}, V_{IHCMR} max varies 1:1 with V_{CC}. The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between V_{PP}min and 1 V.

10EL SERIES NECL DC CHARACTERISTICS $V_{CC} = 0.0 \text{ V}$; $V_{EE} = -5.0 \text{ V}$ (Note 6)

			-40 °C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I _{EE}	Power Supply Current		26	31		26	31		26	31	mA
V _{OH}	Output HIGH Voltage (Note 7)	- 1080	- 990	- 890	- 980	- 895	- 810	- 910	- 815	- 720	mV
V _{OL}	Output LOW Voltage (Note 7)	- 1950	- 1800	- 1650	- 1950	- 1790	- 1630	- 1950	- 1773	- 1595	mV
V _{IH}	Input HIGH Voltage (Single-Ended)	- 1230		- 890	- 1130		- 810	- 1060		- 720	mV
V _{IL}	Input LOW Voltage (Single-Ended)	- 1950		- 1500	- 1950		- 1480	- 1950		- 1445	mV
V _{IHCMR}	Input HIGH Voltage Common Mode Range (Differential) (Note 8)	- 2.5		- 0.4	- 2.5		- 0.4	- 2.5		- 0.4	V
I _{IH}	Input HIGH Current			150			150			150	μΑ
I _{IL}	Input LOW Current	0.5			0.5			0.3			μΑ

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained.

- 6. Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary +0.25 V / -0.5 V. 7. Outputs are terminated through a 50 Ω resistor to V_{CC} 2 volts.
- 8. V_{IHCMR} min varies 1:1 with V_{EE} , V_{IHCMR} max varies 1:1 with V_{CC} . The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between V_{PP}min and 1 V.

100EL SERIES PECL DC CHARACTERISTICS $V_{CC} = 5.0 \text{ V}$; $V_{EE} = 0.0 \text{ V}$ (Note 9)

			-40 °C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I _{EE}	Power Supply Current		26	31		26	31		30	36	mA
V _{OH}	Output HIGH Voltage (Note 10)	3915	3995	4120	3975	4045	4120	3975	4050	4120	mV
V _{OL}	Output LOW Voltage (Note 10)	3170	3305	3445	3190	3295	3380	3190	3295	3380	mV
V _{IH}	Input HIGH Voltage (Single-Ended)	3835		4120	3835		4120	3835		4120	mV
V _{IL}	Input LOW Voltage (Single-Ended)	3190		3525	3190		3525	3190		3525	mV
V _{IHCMR}	Input HIGH Voltage Common Mode Range (Differential) (Note 11)	2.5		4.6	2.5		4.6	2.5		4.6	٧
I _{IH}	Input HIGH Current			150			150			150	μΑ
I _{IL}	Input LOW Current	0.5			0.5			0.5			μΑ

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained.

100EL SERIES NECL DC CHARACTERISTICS V_{CC} = 0.0 V; V_{EE} = -5.0 V (Note 12)

			-40 °C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I _{EE}	Power Supply Current		26	31		26	31		30	36	mA
V _{OH}	Output HIGH Voltage (Note 13)	- 1085	- 1005	- 880	- 1025	- 955	- 880	- 1025	- 955	- 880	mV
V _{OL}	Output LOW Voltage (Note 13)	- 1830	- 1695	- 1555	- 1810	- 1705	- 1620	- 1810	- 1705	- 1620	mV
V _{IH}	Input HIGH Voltage (Single-Ended)	- 1165		- 880	- 1165		- 880	- 1165		- 880	mV
V _{IL}	Input LOW Voltage (Single-Ended)	- 1810		- 1475	- 1810		- 1475	- 1810		- 1475	mV
V _{IHCMR}	Input HIGH Voltage Common Mode Range (Differential) (Note 14)	- 2.5		- 0.4	- 2.5		- 0.4	- 2.5		- 0.4	V
I _{IH}	Input HIGH Current			150			150			150	μΑ
I _{IL}	Input LOW Current	0.5			0.5			0.5			μΑ

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained.

- 12. Input and output parameters vary 1:1 with V_{CC} . V_{EE} can vary +0.8 V / -0.5 V.
- 13. Outputs are terminated through a 50 Ω resistor to V_{CC} 2 volts.
- 14. V_{IHCMR} min varies 1:1 with V_{EE}, V_{IHCMR} max varies 1:1 with V_{CC}. The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between V_{PP}min and 1 V.

^{9.} Input and output parameters vary 1:1 with V_{CC} . V_{EE} can vary +0.8 V / -0.5 V. 10. Outputs are terminated through a 50 Ω resistor to V_{CC} - 2 volts. 11. V_{IHCMR} min varies 1:1 with V_{EE} , V_{IHCMR} max varies 1:1 with V_{CC} . The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between Vppmin and 1 V.

AC CHARACTERISTICS $V_{CC} = 5.0 \text{ V}$; $V_{EE} = 0.0 \text{ V}$ or $V_{CC} = 0.0 \text{ V}$; $V_{EE} = -5.0 \text{ V}$ (Note 15)

			-40 °C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f _{max}	Maximum Toggle Frequency					1.5					GHz
t _{PLH} t _{PHL}	Propagation Delay to Output	135	260	385	190	265	340	215	29*0	365	ps
t _{SKEW}	Within-Device Skew (Note 16) Duty Cycle Skew (Note 17)		5 5			5 5	20 20		5 5	20 20	ps
t _{JITTER}	Random Clock Jitter (RMS)					0.6					ps
V_{PP}	Input Swing (Note 18)	150		1000	150		1000	150		1000	mV
t _r t _f	Output Rise/Fall Times Q (20% - 80%)	100	225	350	100	225	350	100	225	350	ps

^{15.10} Series: V_{EE} can vary +0.25 V / -0.5 V. 100 Series: V_{EE} can vary +0.8 V / -0.5 V.

^{17.} Duty cycle skew is the difference between a t_{PLH} and t_{PHL} propagation delay through a device. 18. $V_{PP}(min)$ is minimum input swing for which AC parameters guaranteed. The device has a DC gain of \approx 40.

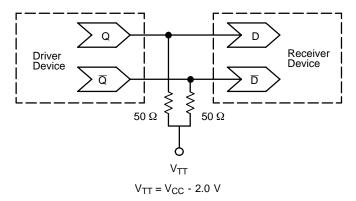


Figure 2. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020 - Termination of ECL Logic Devices.)

^{16.} Within-device skew defined as identical transitions on similar paths through a device.

Resource Reference of Application Notes

AN1404 ECLinPS Circuit Performance at Non-Standard $V_{\mbox{\scriptsize IH}}$ Levels

AN1405 ECL Clock Distribution Techniques AN1406 Designing with PECL (ECL at +5.0 V) ECLinPS I/O SPICE Modeling Kit AN1503

AN1504 Metastability and the ECLinPS Family AN1560 Low Voltage ECLinPS SPICE Modeling Kit

AN1568 Interfacing Between LVDS and ECL AN1596 ECLinPS Lite Translator ELT Family SPICE I/O Model Kit

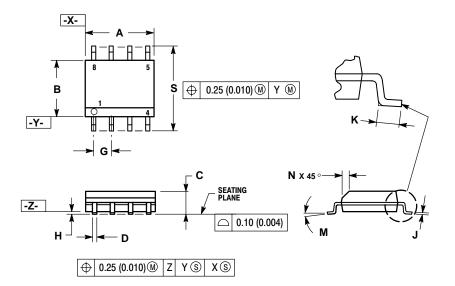
AN1650 Using Wire-OR Ties in ECLinPS Designs

AN1672 The ECL Translator Guide AND8001 Odd Number Counters Design AND8002 Marking and Date Codes

AND8020 Termination of ECL Logic Devices AND8090 AC Characteristics of ECL Devices

PACKAGE DIMENSIONS

SO-8 **D SUFFIX** PLASTIC SOIC PACKAGE CASE 751-07 **ISSUE AA**



NOTES:

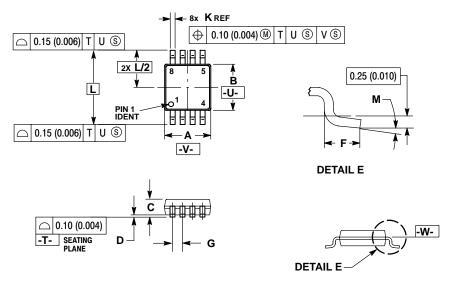
- IOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSION A AND B DO NOT INCLUDE MOLD
- PROTRUSION.
 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER
- 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
 5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
 6. 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

	MILLIM	METERS	INCHES			
DIM	MIN	MAX	MIN	MAX		
Α	4.80	5.00	0.189	0.197		
В	3.80	3.80 4.00		0.157		
С	1.35	1.75	0.053	0.069		
D	0.33	0.51	0.013	0.020		
G	1.27	7 BSC	0.050 BSC			
Н	0.10	0.25	0.004	0.010		
J	0.19	0.25	0.007	0.010		
K	0.40	1.27	0.016	0.050		
M	0 °	8 °	0 °	8 °		
N	0.25	0.50	0.010	0.020		
S	5.80	6.20	0.228	0.244		

PACKAGE DIMENSIONS

TSSOP-8 **DT SUFFIX** PLASTIC TSSOP PACKAGE CASE 948R-02 ISSUE A



- DIMENSIONS AND TOLERANCING PER ASME Y14.5M, 1994
- CONTROLLING DIMENSION: MILLIMETER.
- DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION.
- INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
- TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
 DIMENSION A AND B ARE TO BE
- DETERMINED AT DATUM PLANE -W-.

	MILLIN	IETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	2.90	3.10	0.114	0.122	
В	2.90	3.10	0.114	0.122	
С	0.80	1.10	0.031	0.043	
D	0.05	0.15	0.002	0.006	
F	0.40	0.70	0.016	0.028	
G	0.65	BSC	0.026	BSC	
K	0.25	0.40	0.010	0.016	
L	4.90	BSC	0.193 BSC		
M	0°	6 °	0°	6°	

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